Amendments to the Claims:

an upper surface of the pillar portion; and

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A surface-emitting light emitting device capable of emitting light in a direction perpendicular to a substrate, comprising:

an emitting surface that emits the light;

a base member that is provided on the emitting surface; and an optical member that is provided on an upper surface of the base member-member;

the surface-emitting light emitting device being a surface-emitting semiconductor laser;

the substrate being a semiconductor substrate;

the surface-emitting semiconductor laser being formed on the semiconductor substrate, including a resonator having a pillar portion, and the emitting surface provided on

a diameter of the base member being smaller than a diameter of the pillar portion.

- (Original) The surface-emitting light emitting device according to Claim 1, the base member being made of a material that transmits light of a predetermined wavelength.
 - (Original) The surface-emitting light emitting device according to Claim 1, the optical member functioning as a lens.
 - 4. (Original) The surface-emitting light emitting device according to Claim 1, the optical member functioning as a polarizer.

- 5. (Original) The surface-emitting light emitting device according to Claim 1, the optical member being in the shape of a sphere or an oval sphere.
- 6. (Original) The surface-emitting light emitting device according to any of
 Claim 1,
 a sealing member being formed so as to cover at least part of the optical
 member.
 - 7. (Original) The surface-emitting light emitting device according to Claim 1, the upper surface of the base member being a curved surface.
- 8. (Original) The surface-emitting light emitting device according to Claim 1, an angle made between the upper surface of the base member and a surface on a side part of the base member that contacts the upper surface being an acute angle.
 - 9. (Canceled)
 - 10. (Canceled)
- 11. (Currently Amended) The surface-emitting light emitting device according to Claim 9, Claim 1,

the substrate being a semiconductor substrate;

the surface-emitting semiconductor laser including a resonator formed on the semiconductor substrate; and

the emitting surface being provided on a rear surface of the semiconductor substrate.

12. (Currently Amended) The surface-emitting light emitting device according to Claim 9. Claim 1,

the substrate being a semiconductor substrate;

the surface-emitting semiconductor laser including a resonator formed on the semiconductor substrate;

a concave part being formed in a rear surface of the semiconductor substrate;
a light path adjusting layer being formed by being buried in the concave part;
and

the emitting surface being provided on an upper surface of the light path adjusting layer.

- 13. (Original) The surface-emitting light emitting device according to Claim 1, the surface-emitting light emitting device being a semiconductor light emitting diode.
- 14. (Currently Amended) The surface emitting light emitting device according to

 Claim 13, A surface-emitting light emitting device capable of emitting light in a direction

 perpendicular to a substrate, comprising:

 an emitting surface that emits the light;

 a base member that is provided on the emitting surface;

 an optical member that is provided on an upper surface of the base member;

 the substrate being a semiconductor substrate;

 the semiconductor light emitting diode including a light emitting element that is formed on the semiconductor substrate, and a pillar portion that includes an active layer

that forms at least part of the light emitting element; and
the emitting surface is provided on an upper surface of the pillar
portion: portion; and

a diameter of the base member being smaller than a diameter of the pillar portion.

15. (Currently Amended) The surface-emitting light emitting device according to Claim 10, Claim 1,

the base member being formed integrally with the pillar portion.

- 16. (Original) The surface-emitting light emitting device according to Claim 15, the base member being composed of a semiconductor layer.
- 17. (Canceled)
- 18. (Canceled)
- 19. (Original) The surface-emitting light emitting device according to Claim 1, the optical member functioning as a lens and being in the form of a truncated sphere;

a refractive index of the optical member being approximately equal to a refractive index of the base member;

a radius of curvature "r" of the optical member and a distance "d" from the emitting surface to a highest point of the optical member satisfies,

 $r \le 0.34 * d$.

- 20. (Original) An optical module, comprising:

 the surface-emitting light emitting device according to Claim 1, and an optical wave-guide.
 - 21. (Original) An optical transmission apparatus, comprising: the optical module according to Claim 20.
- 22. (Currently Amended) A method of manufacturing a surface-emitting light emitting device capable of emitting light in a direction perpendicular to a substrate, comprising:
- (a) forming a part that has an emitting surface and functions as the light emitting element;
 - (b) forming a base member on the substrate;
- (c) discharging a droplet onto an upper surface of the base member to form an optical member precursor; and

(a) hardening the optical member precursor to form an optical
member.member;	
the	e surface-emitting light emitting device being a surface-emitting
semiconductor la	ser;
the	e substrate being a semiconductor substrate;
th	e surface-emitting semiconductor laser being formed on the semiconductor
substrate, include	es a resonator having a pillar portion, and the emitting surface provided on an
upper surface of	the pillar portion; and
a	diameter of the base member being smaller than a diameter of the pillar
portion.	
23. (C	Original) The method of manufacturing the surface-emitting light emitting
device according to Claim 22,	
th	e droplet being discharged by using an ink jet method in step (c).
24. (C	Original) The method of manufacturing a surface-emitting light emitting
device according to Claim 22, further comprising:	
(e	adjusting wettability of the upper surface of the base member with respect
to the droplet before (c).	
25. (N	New) The surface-emitting light emitting device according to any of Claim 1,
th	e optical member being formed over an entire top surface of the base
member.	
26. (1	New) The method of manufacturing a surface-emitting light emitting device
according to Claim 22,	
th	ne optical member being formed over an entire top surface of the base
member.	